2.5V Drive Pch+Pch MOS FET

QS6J1

Structure

Silicon P-channel MOS FET

Features

- 1) Two Pch MOS FET transistors in a single TSMT6 package.
- 2) Low on-state resistance with a fast switching.
- 3) Low voltage drive (2.5V).

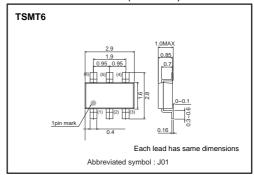
Applications

Switching

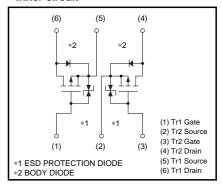
Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
QS6J1		0

●External dimensions (Unit : mm)



•Inner circuit



● Absolute maximum ratings (Ta=25°C)

<It is the same ratings for Tr1 and Tr2>

Parameter		Symbol		Limits	Unit	
Drain-source voltage		V _{DSS}		-20	V	
Gate-source voltage		V _{GSS}		±12	V	
Drain current	Continuous	ΙD		±1.5	Α	
Drain current	Pulsed	I _{DP}	*1	±6	Α	
Source current (Body diode)	Continuous	Is	*1	-0.75	Α	
	Pulsed	I _{SP}		-6	Α	
Total power dissipation		Pn	*2	1.25	W / TOTAL	
		FD		0.9	W / ELEMENT	
Channel temperature		Tch		150	င	
Range of Storage temperature		Tstg		-55 to +150	ဗ	
*1 Pw ≤10μs, Duty cycle ≤1% *2 Mounted on a ceramic board						

Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)*	100	°C / W / TOTAL
Charmer to ambient	Kill (Cli-a)	139	°C/W/ELEMENT

●Electrical characteristics (Ta=25°C)

<It is the same characteristics for Tr1 and Tr2 MOS FET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	±10	μΑ	V _{GS} =±12V, V _{DS} =0V
Drain-source breakdown voltage	V _(BR) DSS	-20	_	_	V	I _D = -1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	-	_	-1	μΑ	V _{DS} = -20V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	-0.7	_	-2.0	V	V _{DS} = -10V, I _D = -1mA
Static drain-source on-state resistance		_	155	215	$m\Omega$	I _D = -1.5A, V _G S= -4.5V
	R _{DS (on)} *	_	170	235	$m\Omega$	I _D = -1.5A, V _G S= -4V
		_	310	430	$m\Omega$	I _D = -0.75A, V _G s= -2.5V
Forward transfer admittance	Y _{fs} *	1.0	_	_	S	V _{DS} = -10V, I _D = -0.75A
Input capacitance	Ciss	_	270	_	pF	V _{DS} = -10V
Output capacitance	Coss	_	40	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	_	35	_	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	_	10	_	ns	I _D = -0.75A
Rise time	tr *	_	12	_	ns	VDD≒ -15V VGS= -4.5V
Turn-off delay time	t _{d (off)} *	_	45	_	ns	$R_L=20\Omega$
Fall time	t _f *	_	20	_	ns	R _G =10Ω
Total gate charge	Qg *	-	3.0	_	nC	V _{DD} ≒ −15V R _L =10Ω
Gate-source charge	Q _{gs} *	-	0.8	_	nC	$V_{GS}=-4.5V$ R _G =10 Ω
Gate-drain charge	Q _{gd} *	-	0.85	_	nC	I _D = -1.5A

^{*}Pulsed

<Body diode (Source-drain)>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	V _{SD}	-	_	-1.2	V	I _S = -0.75A, V _{GS} =0V

Electrical characteristic curves

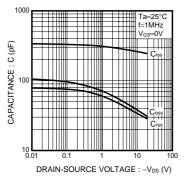


Fig.1 Typical Capacitance vs. Drain-Source Voltage

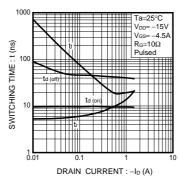


Fig.2 Switching Characteristics

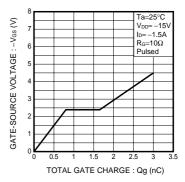


Fig.3 Dynamic Input Characteristics

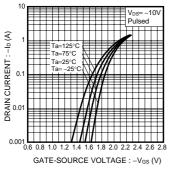


Fig.4 Typical Transfer Characteristics

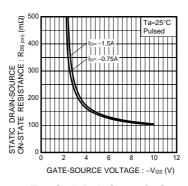


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

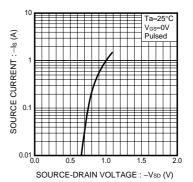


Fig.6 Source Current vs. Source-Drain Voltage

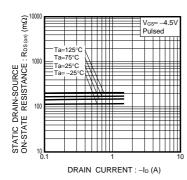


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

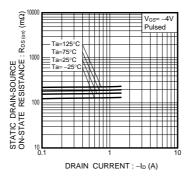


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

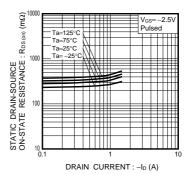


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

Measurement circuits

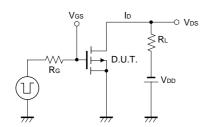


Fig.10 Switching Time Measurement Circuit

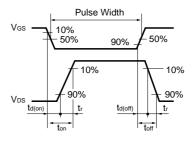


Fig.11 Switching Waveforms

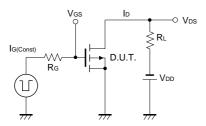


Fig.12 Gate Charge Measurement Circuit

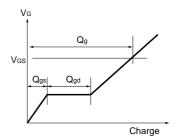


Fig.13 Gate Charge Waveform

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